

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode



Features

- · 3rd generation SiC MOSFET technology
- · High blocking voltage with low on-resistance
- · High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

Benefits

- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

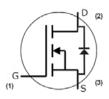
- EV Battery Chargers
- · High Voltage DC/DC Converters

Package









Part Number	Package	Marking
E3M0075120D	TO-247-3L	E3M0075120D

Maximum Ratings (T_c = 25 $^{\circ}$ C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V _{DSmax}	Drain - Source Voltage		1200	٧	
V_{GSmax}	Gate - Source Voltage		-8/+19	٧	Note: 1
	Continuous Drain Current, V_{GS} = 15 V $ \frac{T_C = 25^{\circ}C}{T_C = 100^{\circ}C} $		32	A	Fig. 19
I _D			23		Note: 2
I _{D(pulse)}	Pulsed Drain Current, Pulse width t _P limited by T _{jmax}	80	А	Fig. 22	
P _D	Power Dissipation, T _c =25°C, T _J = 175 °C	145	W	Fig. 20 Note: 2	
T _J , T _{stg}	Operating Junction and Storage Temperature	-55 to +175	°C		
T _L	Solder Temperature, 1.6mm (0.063") from case for 10s			°C	
M _d	Mounting Torque , M3 or 6-32 screw	1 8.8	Nm lbf-in		

Note (1): Recommended turn off / turn on gate voltage $V_{_{GS}}$ - 4V...0V / +15V

Note (2): Verified by design

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			٧	V _{GS} = 0 V, I _D = 100 μA	
V	Gate Threshold Voltage	1.8	2.6	3.6	٧	$V_{DS} = V_{GS}$, $I_D = 5 \text{ mA}$	Fig. 11
V _{GS(th)}	Gate Threshold Voltage		2.1		V	$V_{DS} = V_{GS}$, $I_D = 5$ mA, $T_J = 175$ °C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μΑ	V _{DS} = 1200 V, V _{GS} = 0 V	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
$R_{DS(on)}$	Drain-Source On-State Resistance		75	97.5	mΩ	V _{GS} = 15 V, I _D = 17.9 A	Fig. 4,
• •DS(on)	3.4 334.33 3 3.4		135			V _{GS} = 15 V, I _D = 17.9, T _J = 175°C	5, 6
g fs	Transconductance		11	ļ	s	V _{DS} = 20 V, I _{DS} = 17.9 A	Fig. 7
			10.5			V _{DS} = 20 V, I _{DS} = 17.9 A, T _J = 175°C	1
C _{iss}	Input Capacitance		1480			$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ V to } 1000 \text{ V}$	
C_{oss}	Output Capacitance		58		pF	F = 1 Mhz	Fig. 17, 18
C_{rss}	Reverse Transfer Capacitance		2.7]	Vac = 25 mV	
E _{oss}	Coss Stored Energy		32		μJ	V _{DS} = 1000 V, F = 1 Mhz	Fig. 16
$C_{\text{o(er)}}$	Effective Output Capacitance (Energy Related)		67		pF		1
C _{o(tr)}	Effective Output Capacitance (Time Related)		96		pF	$V_{GS} = 0 \text{ V, } V_{DS} = 0 \text{V to } 800 \text{V}$	Note: 3
Eon	Turn-On Switching Energy (External Diode)		694			$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 20 \text{ A},$ $R_{G(ext)} = 2.5 \Omega, L = 135 \mu\text{H}, T_J = 175 ^{\circ}\text{C}$	Fig. 26
E _{OFF}	Turn Off Switching Energy (External Diode)		137		ijJ	FWD = External SiC DIODE	
E _{on}	Turn-On Switching Energy (Body Diode FWD)		940			$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 20 \text{ A},$ $R_{G(ext)} = 2.5 \Omega, L = 135 \mu\text{H}, T_J = 175 ^{\circ}\text{C}$	Fin. 26
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		164		μJ	FWD = Internal Body Diode	Fig. 26
$t_{\text{d(on)}} \\$	Turn-On Delay Time		52				
t _r	Rise Time		18]	V_{DD} = 800 V, V_{GS} = -4 V/15 V I_{D} = 20 A, $R_{G(ext)}$ = 2.5 Ω ,	Fig. 27,
$t_{\text{d(off)}}$	Turn-Off Delay Time		31		ns	Timing relative to V _{DS}	28
t _f	Fall Time		16			- Industrie roud	
$R_{G(int)}$	Internal Gate Resistance		9		Ω	f = 1 MHz	
Q_{gs}	Gate to Source Charge		19			V _{DS} = 800 V, V _{GS} = -4 V/15 V	
$Q_{\text{gd}} \\$	Gate to Drain Charge		18	_	nC	I _D = 20 A	Fig. 12
\mathbf{Q}_{g}	Total Gate Charge		57			Per IEC60747-8-4 pg 21	

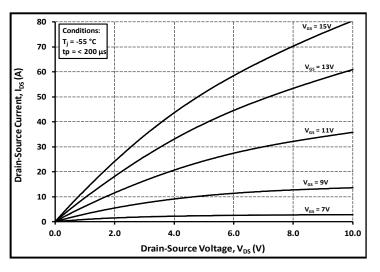
Note (3): C_{o(er)}, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V C_{o(tr)}, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V	V _{SD} Diode Forward Voltage	4.8		٧	$V_{GS} = -4 \text{ V, I}_{SD} = 9 \text{ A, T}_{J} = 25 \text{ °C}$	Fig. 8,
V _{SD}		4.2		٧	V _{GS} = -4 V, I _{SD} = 9 A, T _J = 175 °C	Fig. 8, 9, 10
Is	Continuous Diode Forward Current		27	Α	V _{GS} = -4 V, T _C = 25°C	
I _{S, pulse}	Diode pulse Current		80	Α	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t _{rr}	Reverse Recover time	34		ns		
Q _{rr}	Reverse Recovery Charge	286		nC	$V_{GS} = -4 \text{ V, I}_{SD} = 20 \text{ A, V}_{R} = 800 \text{ V}$ dif/dt = 885 A/ μ s, T $_{J}$ = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	13		Α		
t _{rr}	Reverse Recover time	40		ns		
Q _{rr}	Reverse Recovery Charge	256		nC	V _{GS} = -4 V, I _{SD} = 20 A, V _R = 800 V dif/dt = 740 A/μs, Τ _ι = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	9		Α]	

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.88	1.03	°C/W		Fig. 21



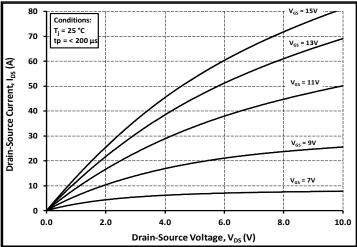
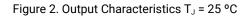
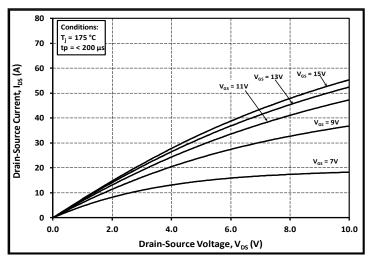


Figure 1. Output Characteristics T_J = -55 °C





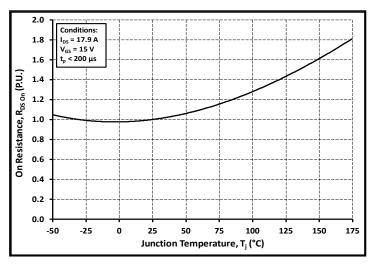
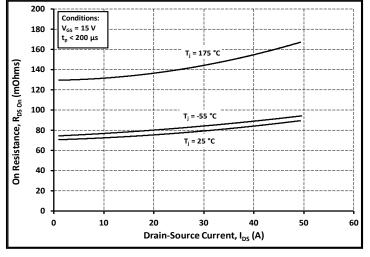


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



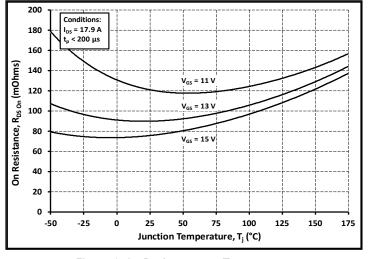
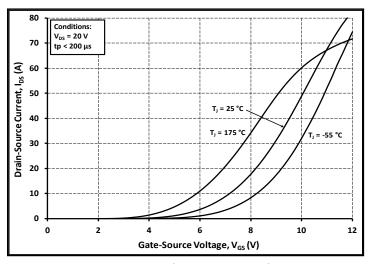
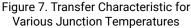


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage





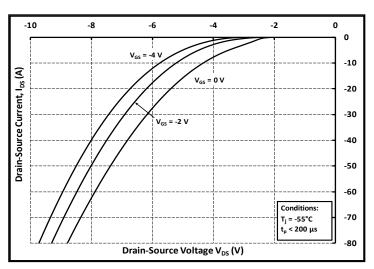


Figure 8. Body Diode Characteristic at -55 °C

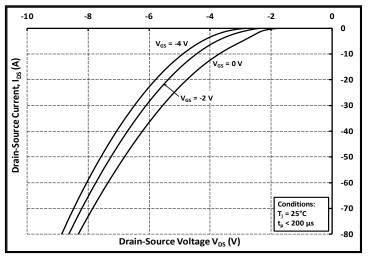


Figure 9. Body Diode Characteristic at 25 °C

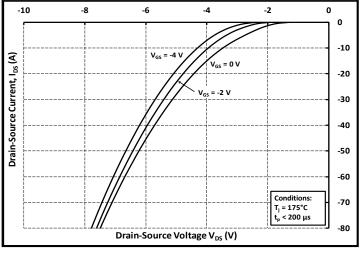


Figure 10. Body Diode Characteristic at 175 °C

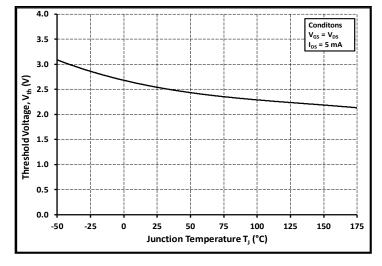


Figure 11. Threshold Voltage vs. Temperature

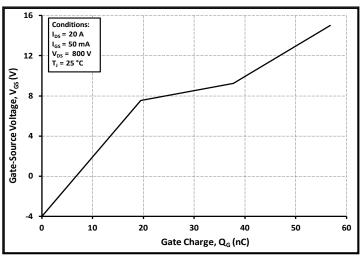


Figure 12. Gate Charge Characteristics

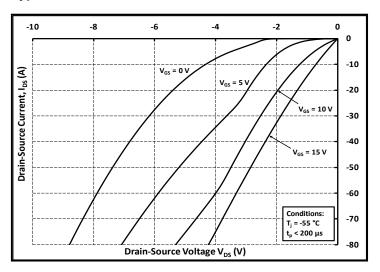


Figure 13. 3rd Quadrant Characteristic at -55 °C

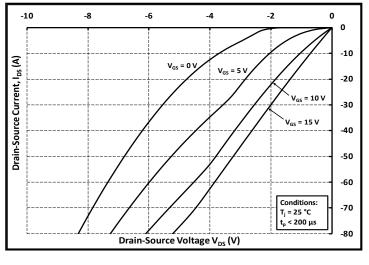


Figure 14. 3rd Quadrant Characteristic at 25 °C

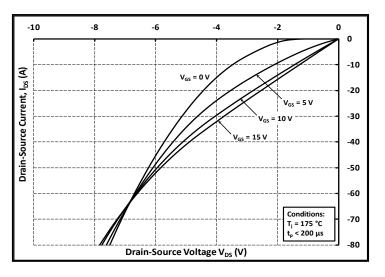


Figure 15. 3rd Quadrant Characteristic at 175 °C

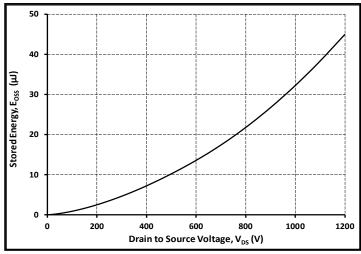


Figure 16. Output Capacitor Stored Energy

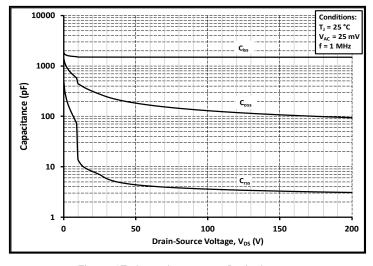


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

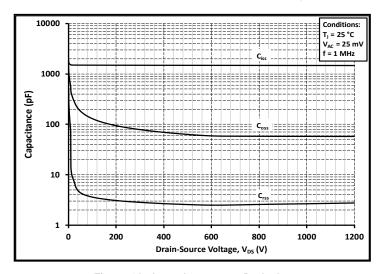
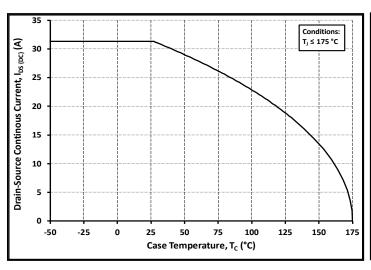


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)



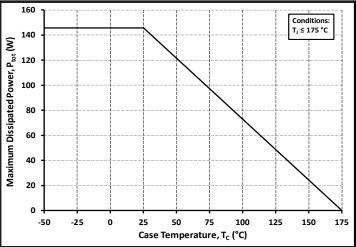
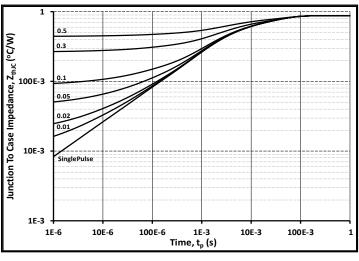


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs.

Case Temperature



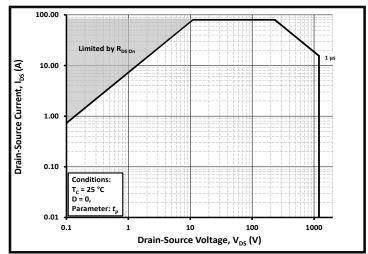
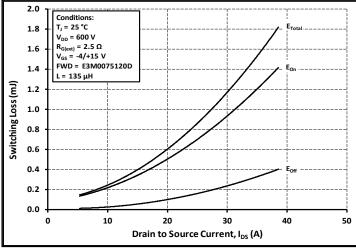


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



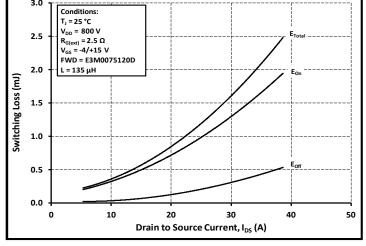


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

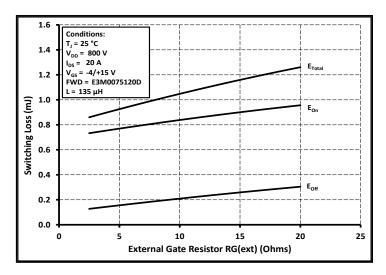


Figure 25. Clamped Inductive Switching Energy vs. $R_{\text{G(ext)}}$

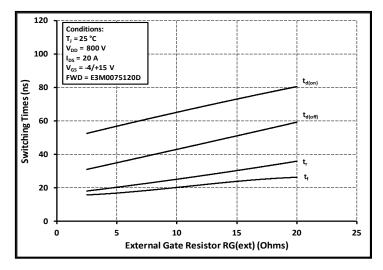


Figure 27. Switching Times vs. $R_{G(ext)}$

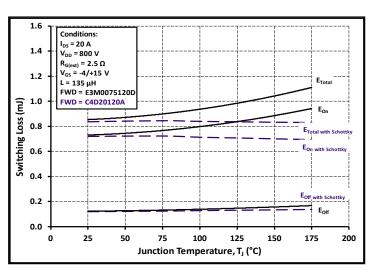


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

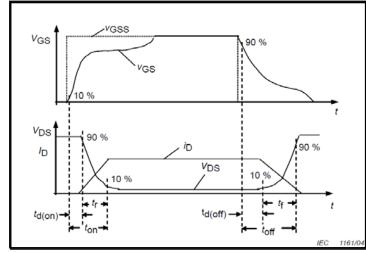


Figure 28. Switching Times Definition

Test Circuit Schematic

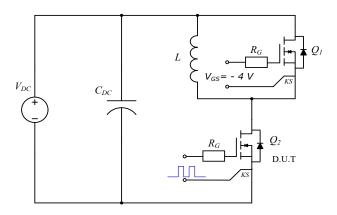
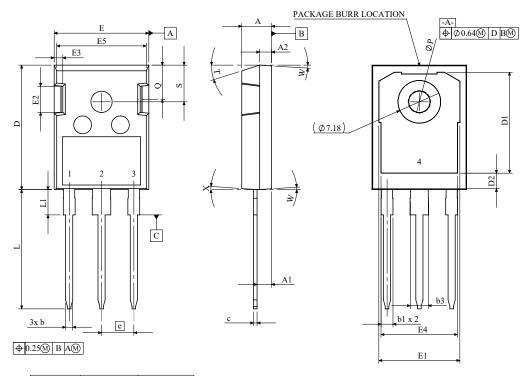


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



SYMBOL	MIN (mm)	MAX (mm)			
A	4.83	5.21			
A1	2.27	2.52			
A2	1.91	2.16			
ь	1.07	1.33			
ь1	1.91	2.41			
b3	2.87	3.38			
c	0.55	0.74			
D	20.75	21.05			
D1	16	17.4			
D2	2.86	3.26			
E	15.75	16.13			
E1	13.5	14.55			
E2	3.68	5.1			
E3	1	1.9			
E4	12.38	13.43			
E5	14.65	15.05			
e	5.44	BSC			
L	19.73	20.48			
L1	3.97	4.69			
ØΡ	3.18	4.06			
Q	5.42	5.96			
S	5.85	6.49			
T	17.5° REF.				
W	3.5° REF.				
X	4° REF.				

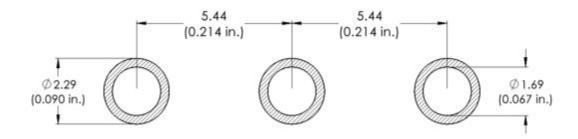
1	GATE	
2	DRAIN	
3	SOURCE	
4	DRAIN	

NOTES

- 1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
- $2. \ \ DIMENSIONING \& TOLERANCING CONFORM \ TO \ ASME \ Y14.5M-1994.$
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Descriptiion of changes
2.0	July-2021	Initial datasheet
3.0	November-2023	Updated format and logo to Wolfspeed
4	January - 2025	Legal Disclaimer Updated
5	March - 2025	Removed V_{AC} from $R_{G(int)}$ test condition Updated Fig 22 E_{ON} and E_{OFF} table values and conditions corrected Fig 25 updated

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